

Solder Pastes and Fluxes for MicroLED Assembly



- **LED Paste NC38HF**
- **LED TACFlux® 007**
- **LEDFlux WS-829**
- **LEDFlux NC-809**

Contact our engineers: askus@indium.com
Learn more: www.indium.com

All of Indium Corporation's solder paste and preform manufacturing facilities are IATF 16949:2016 certified. Indium Corporation is an ISO 9001:2015 registered company.

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- **LEDPaste NC38HF**
 - No-clean, halogen-free
 - Formulated for fine feature printing
 - Superior wetting performance
 - High tack strength for LED transfer
- **LED TACFlux® 007**
 - Tolerates a wide range of reflow temperatures for LED die-attach
 - Suitable for use with high tin-containing and gold-tin solder alloys
 - Cleans easily with solvents and semi-aqueous solutions
 - Tolerates a wide range of reflow temperatures for LED die-attach
- **LEDFlux WS-829**
 - Halogen-free
 - High tackiness holds the smallest microLED in place
 - Best cleanability
- **LEDFlux NC-809**
 - Halogen-free, ultra-low residue
 - Superior wetting performance

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